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ommissioner of Patents: 'ashington, D.C. 20231 ox Assignment مر



	Please record the attached original document or copy thereof.				
	1. Name of party or parties conveying an	2. Name and address of party or parties			
	interest:	receiving an interest:			
	2/14/09	Hynix Semiconductor Inc.			
	Jae-chang Jung	San 136-1, Ami-ri Bubal-eup			
	Ki-soo Shin	Icheon-shi, Gyunggi-do			
		Republic of Korea			
	3. Description of the interest conveyed:				
	X Assignment	Other:			
	Merger				
	Change of Name				
	Security Agreement	10/0/954			
	Execution Date: November 13, 2002	10/6/9254			
	4. Application number(s) or patent number(s)). If the document is being filed together with a			
	Additional sheet attached?	new application, the execution date of the			
	YES NO_X	application is: July 14, 2003			
	A. Patent application no.	B. Patent no.(s):			
	5. Name and address of party to whom	6. Number of applications and/or patents			
	correspondence concerning this cover sheet	identified on this cover sheet: 1			
	should be mailed:				
	Andrew M. Lawrence	7. Amount of fee enclosed or authorized to be			
	Reg. No. 46,130	charged: \$ 40.00			
	MARSHALL, GERSTEIN & BORUN				
	6300 Sears Tower	8. Any additional required fee may be charged,			
	233 South Wacker Drive	or any overpayment credited to our deposit			
	Chicago, Illinois 60606-6357	account: 13-2855			
	9. To the best of my knowledge and belief, the information contained on this cover sheet is true and correct and any copy submitted is a true copy of the original document.				
	July 14, 2003	andrew M. Jamener			
	A	ndrew M. Lawrence, Reg. No. 46,130			
	Total number of pages including cover sheet, atta	achments, and document: 3			
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PATENT REEL: 014288 FRAME: 0483 Foreign

Serial No:

Atty. Docket No. 29925/39028

ASSIGNMENT

Filed:	HEREW	ITH				
Title:	Organic	Anti-Reflective	Coating	Composition	and	Metho

For ten dollars (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign to. Hynix Semiconductor Inc. of San 136-1, Ami-ri, Bubal-eup. Icheon-shi, Gyunggi-do, Republic of Korea (hereinafter "assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in the above-identified application for Letters Patent of the United States, and in said application and any and all other applications, both United States and foreign, which the undersigned may file, either solely or jointly with others, on said invention or improvements, and in any and all Letters Patent of the United States and foreign countries, which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue said Letters Patent to said assignee.

The undersigned hereby authorize(s) and request(s) the attorneys of record in said application to insert in this assignment the executed date and/or filing date and serial number of said application when officially known.

The undersigned warrant(s) themselves (himself/herself) to be the owners (owner) of the interest herein assigned and to have the right to make this assignment and further warrant that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned.

For said consideration the undersigned hereby agree(s), upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional, continuation, continuation-in-part and substitute applications for said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application, and any and all applications and other documents for Letters Patent in foreign countries on said invention or improvements, that said assignee, its successors or assigns, may deem necessary or expedient, and for said consideration the undersigned further agree(s) upon the request of said assignee, its successors or assigns, in the event of any application or Letters Patent assigned herein becoming involved in Interference, to cooperate to the best of the ability of the undersigned with said assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said Letters Patent, both United States and foreign, and vest all rights therein hereby conveyed in said assignee, its successors and assigns, whereby said Letters Patent will be held and enjoyed by said assignee, its successors and assigns, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

REEL: 014288 FRAME: 0484

Foreign		
WITNESS my (our) hand(s) this	13th	day ofNovember, 2002.
Witnesses: 1)		Jung, Jac Chang JUNG. Jac-chang
		1/- 00

RECORDED: 07/14/2003

PATENT REEL: 014288 FRAME: 0485